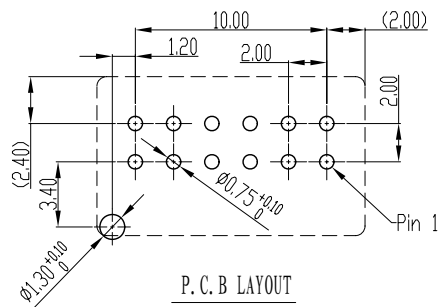
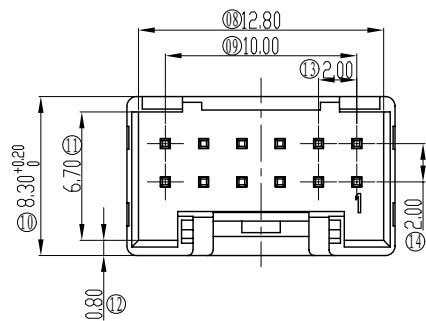
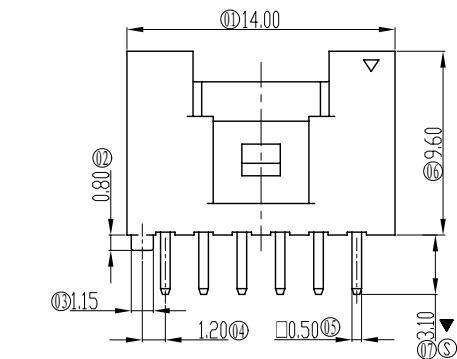
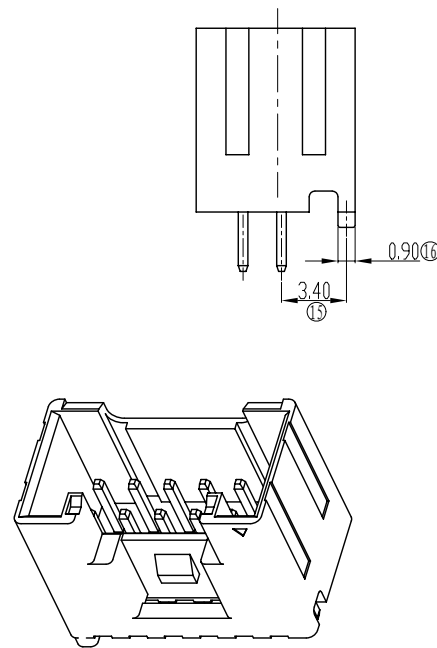


A
B
C
D
E



P.C.B LAYOUT
TOP VIEW
Tolerance: ±0.05



Unless otherwise specified tolerance:

X.	±0.50	X.°	±3°
.X	±0.38	.X°	±2°
.XX	±0.25		

					SL0.1331.001			
					2.0mm Pitch Dual-Row wafer			
Mark	NO.	File NO.	Signature	Date	Projection	Rev.	Weight	Scale
DRAW			An.Cheng	2015.04.02		A0		
CHK					All Dimensions in mm			
MAN					Sheet 1 of 1			
STD					SHINNING SHENZHEN SHINNING ELECTRONIC CO.,LTD.			
APP								

Performance characteristics:

1.Main body part material

Insulator: PA66+GF Natural UL94V-0

Contact terminal: Brass,1.27~2μm Ni under plated,
outer plating Sn 3~5μm

2.Electrical requirements:

Current rating: 3A

Voltage rating: 250 V

Contact resistance: ≤20 mΩ

Insulation resistance: ≥1000 MΩ

Withstanding voltage: 800 Vr.m.s, 1mA, 60s

3.Environment specification

Working temperature: -25℃~85℃

Humidity: ≤93% at 40℃

Resistance to soldering heat: 260℃±5℃, 10s

4.Packing & storing

Method of packing: Plastic bag, small outer box

Storing condition: temperature of -10℃~+40℃
below 80% relative humidity

5.Style of installation: solder PCB installation.

6.To prevent the pollution of the environment product info

RoHS agreement:In line with the european union RoHS.